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Atty. Docket: 35.C14077

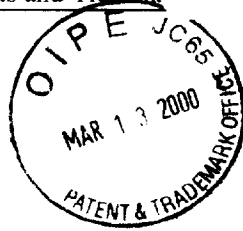
To the Commissioner of Patents and Trademarks

101333080

Documents or copy thereof.

1. Name of conveying party(ies):

- (1) Takao YONEHARA
- (2) Kunio WATANABE
- (3) Testsuya SHIMADA
- (4) Kazuaki OF MI
- (5) Kiyofumi SAKAGUCHI



Additional name(s) of conveying party(ies) attached?

Yes No

2. Name and address of receiving party(ies):

Name: CANON KABUSHIKI KAISHA

Foreign Address: 30-2, Shimomaruko 3-chome, Ohta-ku, Tokyo, Japan

Domestic Address: _____

City: _____ State _____ ZIP _____

Additional name(s) & address(es) attached? Yes No

3. Nature of conveyance:

- Assignment Merger
- Security Agreement Change of Name
- Other _____

Execution Date: (1) January 15, 2000 (2) January 20, 2000
(3, 4, 5) January 13, 2000

4. Application number(s) or patent number(s):

If this document is being filed together with a new application, the execution date of the application is: _____

A. Patent Application Number: 09/453,539

Filing Date: December 3, 1999

B. Title of Invention:

METHOD OF MANUFACTURING SEMICONDUCTOR
WAFER METHOD OF USING AND UTILIZING THE
SAME

Additional numbers attached? Yes No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: Fitzpatrick, Cella, Harper & Scinto

30 Rockefeller Plaza

New York, New York 10112-3801

Telephone No.: (212) 218-2100

Facsimile No.: (212) 218-2200

6. Number of applications and patents involved:

One

7. Total fee (37 CFR 3.41): . . . \$ 40.00

Enclosed

Authorized to be charged to deposit account

8. Deposit account number (for deficiency or excess)

06-1205

(Attach duplicate copy of this page if paying by deposit account):

04/24/2000 DEBATES 01000365 09453539

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19 FC:SA1 Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and the attached is the original document or is a true copy of the original document.

Steven E. Warner - Reg. No. 33,326

March 13, 2000

Name of Person Signing

Signature

Date

Total number of pages including cover sheet, attachments, and documents: 2

SEW:mv

DC, MAIN 17:26 v.1

PATENT
REEL: 010715 FRAME: 0707

ASSIGNMENT OF PATENT RIGHTS FOR THE UNITED STATES

FOR VALUE RECEIVED, WE, TAKAO YONEHARA, KUNIO WATANABE,
TETSUYA SHIMADA, KAZUAKI OHMI and KIYOFUMI SAKAGUCHI

citizens of Japan

residing respectively at 2235-2, Nurumizu, Atsugi-shi, Kanagawa-ken,
Japan; 14-4, Minami Ikuta 2-chome, Tama-ku, Kawasaki-shi,
Kanagawa-ken, Japan; 26-20-503, Sagamigaoka 6-chome, Zama-shi,
Kanagawa-ken, Japan; 581-4, Niiharu-cho, Midori-ku,
Yokonama-shi, Kanagawa-ken, Japan; and 19-2-504, Eda Higashi
2-chome, Tsuzuki-ku, Yokohama-shi, Kanagawa-ken, Japan

hereby sell, assign, transfer and convey unto CANON KABUSHIKI KAISHA

a corporation of Japan

having a place of business at 30-2, Shimomaruko 3-chome, Ohta-ku, Tokyo, Japan

its successors, assigns and legal representatives (hereinafter called the "Assignee"), the entire right, title and interest, for
the United States, in and to certain inventions relating to

METHOD OF MANUFACTURING SEMICONDUCTOR WAFER
METHOD OF USING AND UTILIZING THE SAME

and described in an application for Letters Patent of the United States filed by us on December 3, 1999

and which has been accorded Application No. 09/453,539

and in and to said application, and all divisions, renewals and continuations thereof, and all Letters Patent of the United
States which may be granted, thereon, and all reissues and extensions thereof; and we hereby authorize and request the
Commissioner for Patents and Trademarks of the United States to issue all Letters Patent upon said inventions to the
Assignee or to such nominees as it may designate.

AND we authorize and empower the said Assignee or nominees to invoke and claim for any application for
patent or other form of protection for said inventions, the benefit of the right of priority provided by the International
Convention for the Protection of Industrial Property, as amended, or by any convention which may henceforth be
substituted for it, and to invoke and claim such right of priority without further written or oral authorization from us.

AND we hereby consent that a copy of this assignment shall be deemed a full legal and formal equivalent of any
assignment; consent to file or like document which may be required in the United States for any purpose and more
particularly in proof of the right of said Assignee or nominees to claim the aforesaid benefit of the right of priority
provided by the International Convention for the Protection of Industrial Property, as amended, or by any convention
which may henceforth be substituted for it.

AND we hereby covenant that we have the full right to convey the entire right, title and interest herein assigned
and that we have not executed and will not execute any agreement in conflict herewith.

AND we hereby covenant and agree that we will communicate to said Assignee or nominees all facts known to
us pertaining to said inventions, and testify in all legal proceedings, sign all lawful papers, execute all divisional,
continuing and reissue applications, make all rightful oaths and declarations and in general perform all lawful acts
necessary or proper to aid said Assignee or nominees in obtaining, maintaining and enforcing all lawful patent protection
for said inventions in the United States.

By Takao Yonehara
TAKAO YONEHARA

Date: January 15, 2000

By Kunio Watanabe
KUNIO WATANABE

Date: Jan. 20, 2000

By Tetsuya Shimada
TETSUYA SHIMADA

Date: January 13, 2000

By Kazuaki Ohmi
KAZUAKI OHMI

Date: January 13, 2000

By Kiyofumi Sakaguchi
KIYOFUMI SAKAGUCHI

Date: January 13, 2000

PATENT

RECORDED: 03/13/2000

REEL: 010715 FRAME: 0708